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N-Channel PowerTrench[®] SyncFETTM 25 V, 49 A, 1.25 m Ω

Features

- Max $r_{DS(on)}$ = 1.25 m Ω at V_{GS} = 10 V, I_D = 32 A
- Max $r_{DS(on)}$ = 1.75 m Ω at V_{GS} = 4.5 V, I_D = 28 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

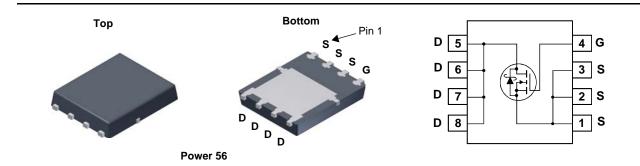


General Description

The FDMS7558S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for Synchronous Buck Converters
- Notebook
- Server
- Telecom
- High Efficiency DC-DC Switch Mode Power Supplies



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			25	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		49		
	-Continuous (Silicon limited)	T _C = 25 °C		199		
	-Continuous	T _A = 25 °C	(Note 1a)	32	Α	
	-Pulsed			180		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	288	mJ	
P _D	Power Dissipation	T _C = 25 °C		89	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.4	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1	a) 50	C/W

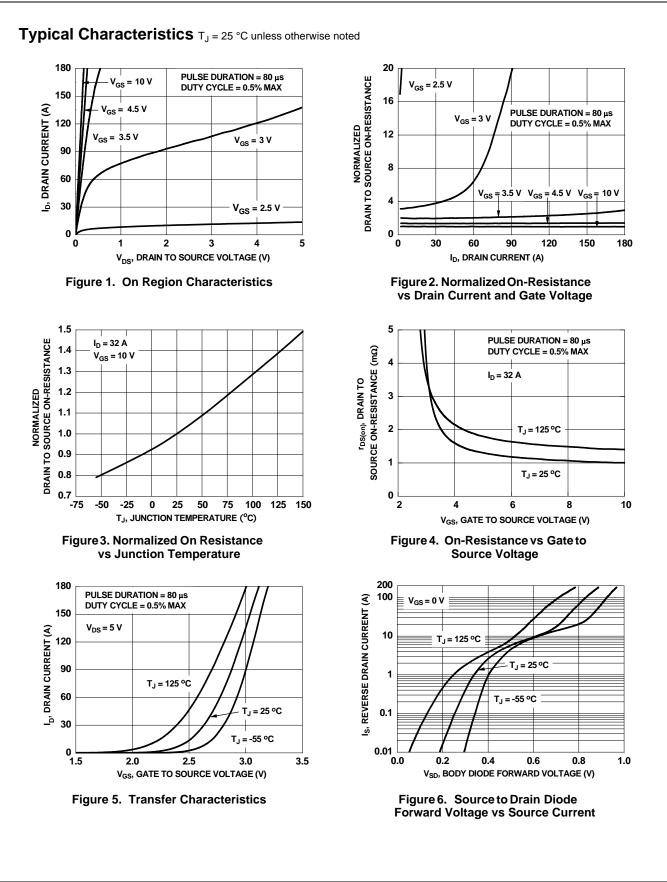
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FDMS7558S	FDMS7558S	Power 56	13 "	12 mm	3000 units	

FDMS7558S N
I -Channel
PowerTrench
[®] SyncFET

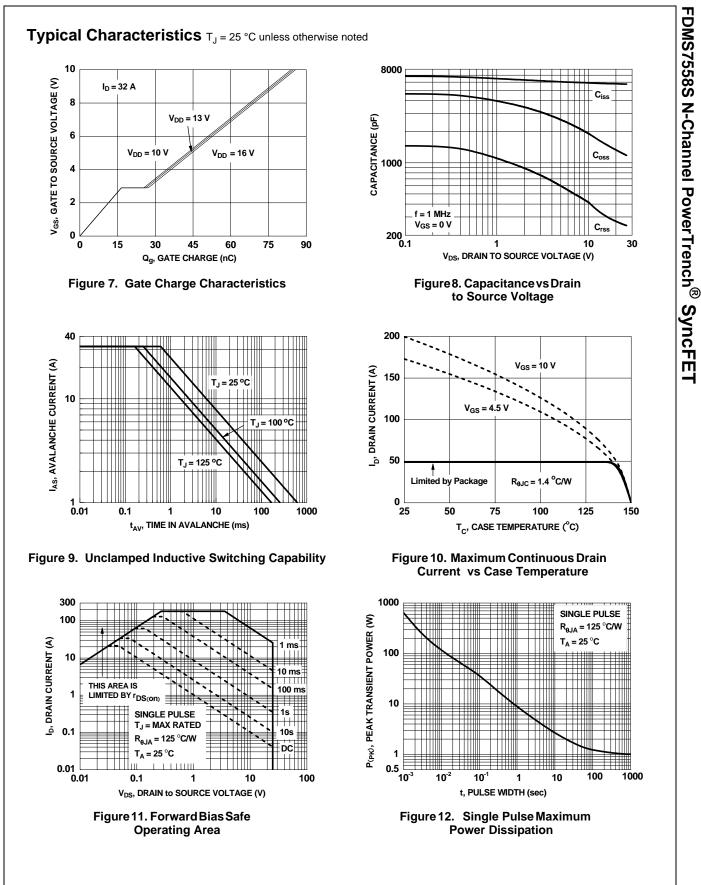
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V				V
$\frac{\Delta BV_{DSS}}{\Delta T_{I}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}, \text{ referenced to 25 °C}$	25	21		mV/°0
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V			500	μA
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics (Note 2)					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.6	3.0	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		-5		mV/°0
		V _{GS} = 10 V, I _D = 32 A		1.0	1.25	mΩ
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 28 \text{ A}$		1.4	1.75	
		V_{GS} = 10 V, I_D = 32 A, T_J = 125 °C		1.4	1.8	
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 32 A$		221		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	V 12 V V 0 V		5843	7770	pF
C _{oss}	Output Capacitance	− V _{DS} = 13 V, V _{GS} = 0 V, − f = 1 MHz		1615	2150	pF
C _{rss}	Reverse Transfer Capacitance			317	475	pF
R _g	Gate Resistance			0.5	1.0	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			18	33	ns
t _r	Rise Time	V _{DD} = 13 V, I _D = 32 A,		9	18	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		44	70	ns
t _f	Fall Time			5	10	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		85	119	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 13 V,$		39	55	nC
Q _{gs}	Gate to Source Gate Charge	I _D = 32 A		16.5		nC
Q _{gd}	Gate to Drain "Miller" Charge			9.7		nC
Drain-Sou	urce Diode Characteristics					
Ver	Source to Drain Diode, Forward Voltage	$V_{GS} = 0 V, I_{S} = 2 A$ (Note 2)		0.38	0.7	V
• 50		$V_{GS} = 0 V, I_S = 32 A$ (Note 2)		0.75	1.2	
t _{rr}	Reverse Recovery Time	I _E = 32 A. di/dt = 300 A/us		39	63	ns
	Reverse Recovery Charge			52	84	nC
Q _{rr} Notes:	Reverse Recovery Charge nined with the device mounted on a 1in ² pad 2 oz copper pad rd design.	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 32 \text{ A} \qquad (\text{Note } 2)$ $- \text{ I}_{F} = 32 \text{ A}, \text{ di/dt} = 300 \text{ A/}\mu\text{s}$ $\text{I on a } 1.5 \text{ x } 1.5 \text{ in. board of FR-4 material. } \text{R}_{\text{aJC}} \text{ is}$		0.75 39 52 by design wh	1.2 63 84 hile R _{0CA} is do	n: n(
	a. 50 °C/W when m 1 in ² pad of 2 oz			XW when mo um pad of 2 (
2. Pulse Test: Pu	ulse Width < 300 μs, Duty cycle < 2.0%.					

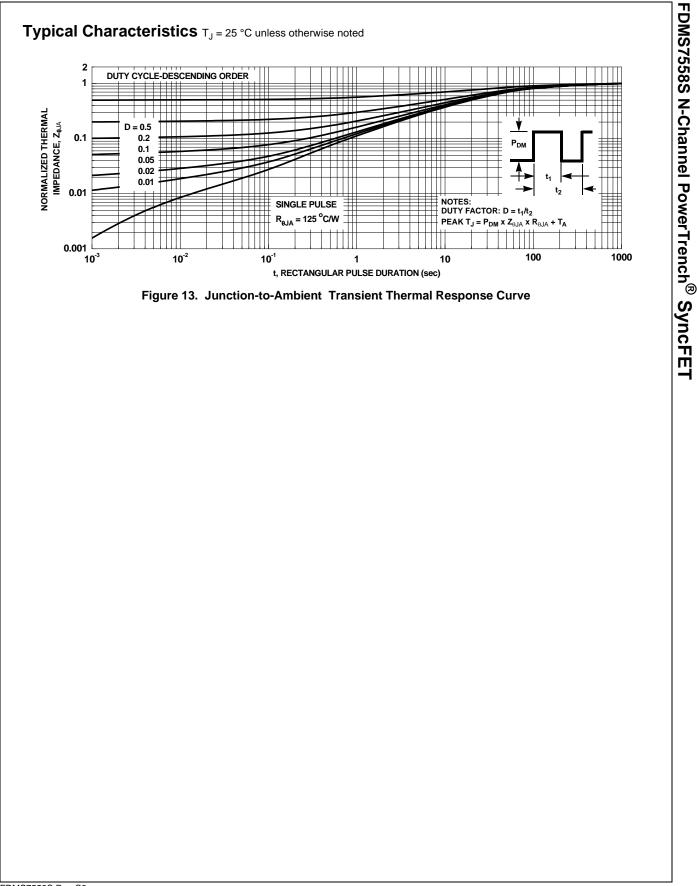
FDMS7558S N-Channel PowerTrench[®] SyncFET



FDMS7558S Rev.C3

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Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS7558S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

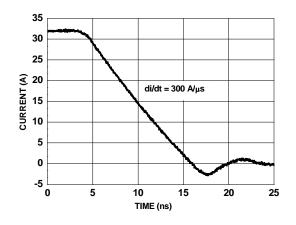
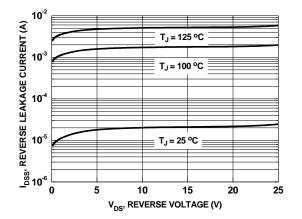
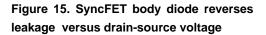


Figure 14. FDMS7558S SyncFET body diode reverse recovery characteristic







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